



Product Change Notification

Change Notification #: 114428 - 02
Change Title: Intel® Server Systems R2308WTTYSR,
Intel® Server Systems R2312WTTYSR,
Intel® Server Systems R2000WTXXX,
Intel® Server Systems R2208WT2YSR,
Intel® Server Systems R2208WTTYC1R,
Intel® Server Systems R2208WTTYSR,
Intel® Server Systems R2224WTTYYS,
Intel® Server Systems R2224WTTYYSR,
Intel® Server Systems R2308WTTYYS,
Intel® Server Systems R2312WTTYYS,
Intel® Server Systems R2312WTXXX,
Intel® Server Systems SDP2308BWTT,
Intel® Server Systems SDP2308SWTT,
Intel® Server Systems SDP2308WTTAPP,
PCN 114428-02, Product Design,
Cover added to rear panel DB9 hole
connector, added paint specification applying
to R2312WTTYSR only
Reason for Revision: Adding products to the
Products Affected/Intel Ordering Codes table

Date of Publication: March 17, 2016

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	March 1, 2016
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Reason for Revision: Adding products to the Products Affected/Intel Ordering Codes table.

Intel is implementing the following changes on the 2U Intel® Server Systems

1. Add paint specification to rack ears only for Intel® Server System R2312WTTYSR.
2. Add a new cover in the rear panel for the DB9 connector on 2U S2000WT systems.
 - a. Image 1 shows the DB9 rear panel hole that is going to be covered
 - b. Image 2 shows the DB9 rear panel hole after the cover is installed
 - c. Image 3 shows the DBA cover.

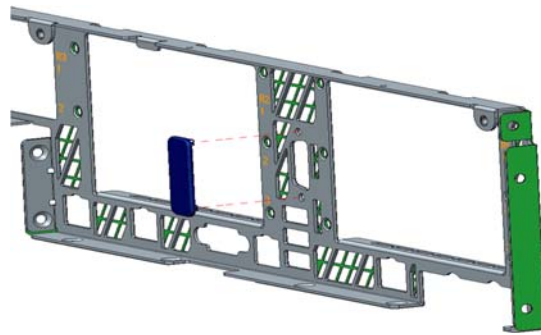


Image 1 “DB9 rear panel hole”

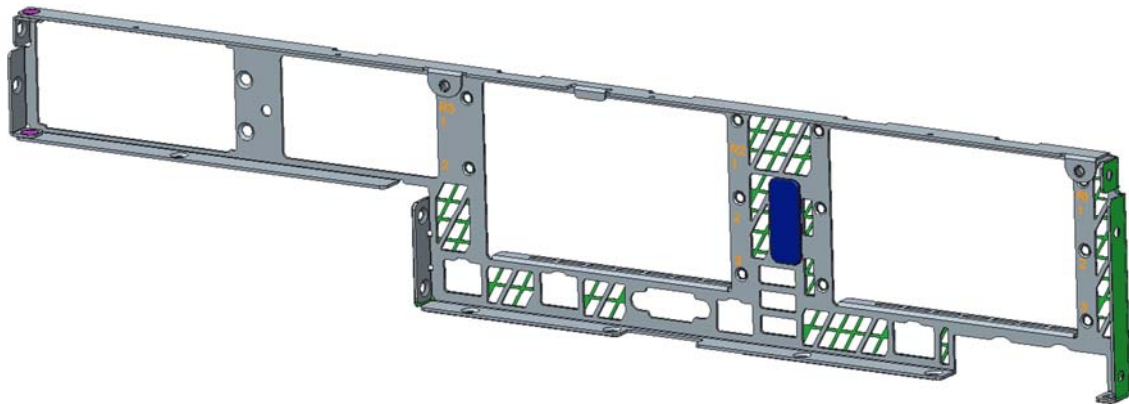


Image 2 “DB9 rear panel hole with cover”

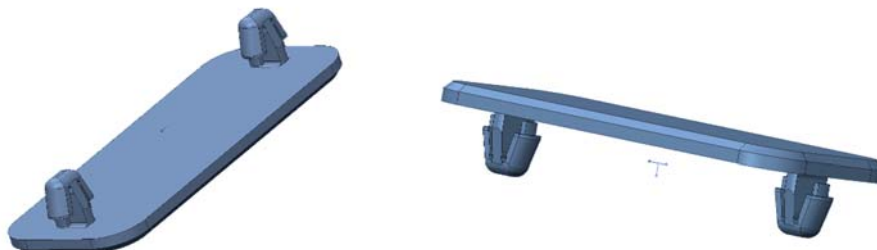


Image 3 “DB9 cover”

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre-Change TA	Post-Change TA
R2312WTTYSR	943830	J11495-002	J11495-003
R2308WTTYSR	943829	J11493-002	J11493-003
R2000WTXXX	936021	H46995-001	H46995-002
R2208WT2YSR	943827	J11485-001	J11485-002
R2208WTTYC1R	943828	J11487-001	J11487-002
R2208WTTYSR	943826	J11484-001	J11484-002
R2224WTTYS	936037	H46996-002	H46996-003
R2224WTTYSR	943831	J11492-002	J11492-003
R2308WTTYS	936035	H46990-002	H46990-003
R2312WTTYS	936036	H46999-002	H46999-003
R2312WTXXX	936022	H46998-002	H46998-003
SDP2308BWTT	942092	H72148-001	H72148-002
SDP2308SWTT	942093	H72162-001	H72162-002
SDP2308WTTAPP	939224	H55019-001	H55019-002

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
February 26, 2016	00	Originally Published PCN
February 29, 2016	01	Resending PCN
March 17, 2016	02	Adding products to the Products Affected/Intel Ordering Codes table.



Product Change Notification

#114428 - 02

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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